# SENSITRON SEMICONDUCTOR

TECHNICAL DATA DATA SHEET 552, REV. -

# HERMETIC POWER MOSFET N-CHANNEL

### FEATURES:

- 200 Volt, 0.045 Ohm, 50A MOSFET
- Isolated Hermetic Metal Package
- Low R<sub>DS (on)</sub>

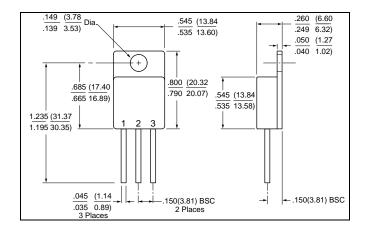
### **MAXIMUM RATINGS**

## ALL RATINGS ARE AT $\rm T_{\rm c}$ = 25°C UNLESS OTHERWISE SPECIFIED.

RATING	SYMBOL	MIN.	TYP.	MAX.	UNITS
GATE TO SOURCE VOLTAGE	V <sub>GS</sub>	-	-	±20	Volts
ON-STATE DRAIN CURRENT	I <sub>D25</sub>	-	-	50	Amps
PULSED DRAIN CURRENT	I <sub>DM</sub>	-	-	200	Amps
OPERATING AND STORAGE TEMPERATURE	T <sub>J</sub> /T <sub>STG</sub>	-55	-	+150	°C
TOTAL DEVICE DISSIPATION	PD	-	-	270	Watts
THERMAL RESISTANCE, JUNCTION TO CASE	R <sub>thJC</sub>	-	-	0.45	°C/W

### **ELECTRICAL CHARACTERISTICS**

CHARACTERISTIC		SYMBOL	MIN.	TYP.	MAX.	UNITS
DRAIN TO SOURCE BREAKDOWN VOL	TAGE	BV <sub>DSS</sub>	200	-	-	Volts
V <sub>GS</sub> -	= 0V, I <sub>D</sub> = 250μA					
STATIC DRAIN TO SOURCE ON STATE	RESISTANCE	R <sub>DS(ON)</sub>	-	-	0.045	Ω
	$10V, I_D = 0.5I_{D25}$					
GATE THRESHOLD VOLTAGE V <sub>DS</sub> = 7	$V_{\rm GS}, I_{\rm D} = 4.0  {\rm mA}$	V <sub>GS(th)</sub>	2.0	-	4.0	Volts
FORWARD TRANSCONDUCTANCE		<b>g</b> <sub>fs</sub>	26	32		S(1/Ω)
	$10V, I_D = 0.5I_{D25}$				-	
ZERO GATE VOLTAGE DRAIN CURREN	IT					
$V_{DS} = 0.8 \text{ x Max. rating, } V_{GS} =$	= 0V, T <sub>J</sub> = 25°C	I <sub>DSS</sub>	-	-	200	μA
	T <sub>J</sub> = 125°C				1000	
GATE TO SOURCE LEAKAGE FORWAR	$V_{GS} = 20V$	I <sub>GSS</sub>	-	-	100	nA
GATE TO SOURCE LEAKAGE REVERS	= V <sub>GS</sub> = -20V				-100	
TURN ON DELAY TIME	$V_{DS} = 0.5V \bullet$	t <sub>d(ON)</sub>	-	18	25	
RISE TIME V	$_{\rm DSS},  {\sf I}_{\rm D} = 0.5 \bullet {\sf I}_{\rm D25}$	t <sub>r</sub>		15	20	nsec
TURN OFF DELAY TIME	V <sub>GS</sub> =10V	t <sub>d(OFF)</sub>		72	90	
FALL TIME	$R_{\rm G} = 1.0\Omega$	t <sub>f</sub>		16	25	
	$I_{\rm F} = I_{\rm S}, V_{\rm GS} = 0V$	V <sub>SD</sub>	_	_	1.5	Volts
Pulse test, t $\leq$ 300 µs, du		v sd	-	-	1.5	VOIIS
REVERSE RECOVERY TIME	$T_{\rm J} = 25^{\circ} \text{C},$				200	
	$I_{\rm J} = 25$ C, =25A, $V_{\rm R} = 100$ V	t <sub>rr</sub>	_	_	200	nsec
		۲r	_	_		11360
	$\frac{dt = 100 \text{A}/\mu \text{sec}}{V_{\text{GS}} = 0 \text{ V},}$	C <sub>iss</sub>		4400		
OUTPUT CAPACITANCE	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$		-	4400 800	-	ъF
REVERSE TRANSFER CAPACITANCE	v <sub>DS</sub> = 25 v, f = 1.0MHz	C <sub>oss</sub>		280		pF
REVENSE IRANSFER CAPACITANCE		C <sub>rss</sub>		200		



#### **MECHANICAL DIMENSIONS:** in Inches / mm

#### <u>TO-254</u>

DEVICE TYPE	PIN-1	PIN-2	PIN-3
N-CHANNEL MOSFET	DRAIN	SOURCE	GATE
TO-254 PACKAGE			

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